Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L33	283	(438/667).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/26 20:33
L34	9	33 and (stack$3 near wafer$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	,ON	2005/04/26 20:34
S1	10017	((438/353) or (438/359) or (438/400) or (438/421) or (438/422) or (438/424) or (438/437) or (438/453) or (438/597) or (438/598) or (438/619) or (438/637) or (438/638) or (438/642) or (438/643) or (438/652) or (438/653) or (438/667) or (438/668) or (438/672) or (438/675)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/02 15:50
S2	9	(("4688069") or ("4733287") or ("4939567") or ("4949151") or ("5644157") or ("5760452") or ("6051868") or ("6472723") or ("6515334")).PN.	USPAT	OR	OFF	2004/11/28 20:49
S3	847	S1 and (((first and second) near2 (dielectric or insulat$3)) same (via$1 or viahole$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/28 20:51
S4	397	S3 and wafer$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/28 20:52
S5	129	S4 and (isolat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/28 21:17

S6	25	("3614541" | "4954458" | "5128831" | "5199165" | "5202754" | "5229647" | "5270261" | "5322816" | "5401672" | "5406120" | "5419806" | "5424245" | "5432999" | "5481133" | "5502667" | "5510655" | "5528080" | "5585675" | "5600541" | "5616517" | "5621616" | "5640051" | "5926951" | "5936843" | "6002177").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/11/28 21:10
S7	268	S4 not S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/28 21:17
S8	1	("4939567").PN.	USPAT	OR	OFF	2004/11/28 21:27
S9	2	(("5644157") or ("6515334")).PN.	USPAT	OR	OFF	2004/11/28 21:27
S10	11	("20010026444" | "20020022277" | "20020037624" | "20030015754" | "5529831" | "5618761" | "5818079" | "5821005" | "5989635" | "6392265" | "6649954").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/11/28 21:45
S11	11	("20010026444" | "20020022277" | "20020037624" | "20030015754" | "5529831" | "5618761" | "5818079" | "5821005" | "5989635" | "6392265" | "6649954").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/11/28 22:03
S12	10208	((438/353) or (438/359) or (438/400) or (438/421) or (438/422) or (438/424) or (438/437) or (438/453) or (438/597) or (438/598) or (438/619) or (438/637) or (438/638) or (438/642) or (438/643) or (438/652) or (438/653) or (438/667) or (438/668) or (438/672) or (438/675)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/15 18:32
S13	4505	S12 and (via$1 or (via$1 near2 hole$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 16:13

S14	2463	S13 and ((insulat$3 or dielectric or barrier) near4 (via$1 or (via$1 near2 hole$1)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 18:38
S15	2406	S14 and (wafer$1 or substrate$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 18:41
S16	1942	S15 and ((die or (die near2 assembl$3)) or (ic or (integrated near2 circuit$1)) or chip$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 18:43
S17	623	S16 and (stack$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 18:44
S18	315	S17 and (conductor$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 18:59
S19	28914	(via$1 near3 structure$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 19:50
S20	5411	(via$1 near3 structure$1) same (insulat$3 or dielectric or barrier)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 20:16
S21	387	(via$1 near3 structure$1) same (insulat$3 or dielectric or barrier) same wafer$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 19:51

S22	381	S21 not S18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 19:51
S23	9	("4688069" | "4733287" | "4939567" | "4949151" | "5644157" | "5760452" | "6051868" | "6472723" | "6515334").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/15 20:00
S24	0	("6750516").URPN.	USPAT	OR	OFF	2005/01/15 20:02
S25	29	("4093503" | "4108715" | "4124933" | "4271422" | "4343675" | "4379001" | "4438556" | "4450041" | "4514251" | "4571817" | "4601778" | "4952446" | "5092957" | "5112771" | "5136344" | "5236547" | "5242863" | "5244826" | "5336912" | "5358908" | "5431777" | "5484740" | "5488011" | "5580811" | "5599736" | "5600174" | "5661064" | "5817580" | "6261964").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/15 20:05
S26	3	("6599840").URPN.	USPAT	OR	OFF	2005/01/15 20:07
S27	929	(via adj structure$1) same (insulat$3 or dielectric or barrier)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 20:17
S28	434	S27 and conductor$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 20:17
S29	234	S28 and wafer$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 20:17
S30	199	S29 not S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/15 20:17

S31	3	("3903427" | "4791248" | "4981525").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/15 20:30
S32	23	("5425816").URPN.	USPAT	OR	OFF	2005/01/15 20:30
S33	245	(438/620).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/23 19:47
S34	271	(438/667).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/26 15:24
S35	0	("002not1").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/23 19:47
S36	260	S34 not S33	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/23 19:47
S37	1	("6743708").PN.	USPAT	OR	OFF	2005/01/23 20:26
S38	2	("6297145" | "6559045").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/23 20:24
S39	0	("6743708").URPN.	USPAT	OR	OFF	2005/01/23 20:25
S40	1	("6498090").PN.	USPAT	OR	OFF	2005/01/23 20:26
S41	2	("6191023" | "6198170").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/23 20:26
S42	1	("6498090").URPN.	USPAT	OR	OFF	2005/01/23 20:32
S43	16	"5529950"	USPAT	OR	OFF	2005/01/23 20:33
S44	1	("5529950").PN.	USPAT	OR	OFF	2005/01/23 20:33
S45	12	("4437109" | "4667220" | "4893174" | "4939568" | "5153814" | "5244817" | "5262021" | "5306647" | "5360759" | "5401672" | "5403752" | "5426072").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/23 22:19
S46	15	("5529950").URPN.	USPAT	OR	OFF	2005/01/23 20:37
S47	66963	("438").CLAS.	USPAT	OR	OFF	2005/01/23 22:23

S48	1	("4939567").PN.	USPAT	OR	OFF	2005/01/23 22:27
S49	1	("5644157").PN.	USPAT	OR	OFF	2005/01/23 22:29
S50	1	("6515334").PN.	USPAT	OR	OFF	2005/01/23 22:29
S51	10447	((438/353) or (438/359) or (438/400) or (438/421) or (438/422) or (438/424) or (438/437) or (438/453) or (438/597) or (438/598) or (438/619) or (438/637) or (438/638) or (438/642) or (438/643) or (438/652) or (438/653) or (438/667) or (438/668) or (438/672) or (438/675)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/03 18:36
S52	4575	S51 and (wafer$1 and substrate$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 15:53
S53	494880	"3" and ((dielectric or insulat$3) near2 (layer$1 or film$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 15:59
S54	3848	S52 and ((dielectric or insulat$3) near2 (layer$1 or film$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 16:09
S55	942	S52 and ((first and second) near ((dielectric or insulat$3) near2 (layer$1 or film$1)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 16:09
S56	629	S55 and (via$1 or (via$1 near2 hole$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/02 16:13
S57	279	(438/667).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/03 18:36
S58	8	("5447871").URPN.	USPAT	OR	OFF	2005/04/03 19:56

S59	1	("6838362").PN.	USPAT	OR	OFF	2005/04/03 23:39
S60	10	("3761782" | "4978639" | "5091331" | "5272104" | "5352926" | "5426072" | "5447871" | "5753529" | "5757081" | "6313531").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/03 23:39
S61	0	("6838362").URPN.	USPAT	OR	OFF	2005/04/03 23:41
S62	283	(438/667).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/26 20:32